

Sn63Pb37 C6

Water Soluble Core Wire

Product Description

Sn63Pb37 C-6 is a water-soluble formula for use in flux-cored solder wire. Sn63Pb37 C-6 has specially been developed to be more heat stable as compare to normal organic water-soluble core flux. The flux is partially decomposed during the heat of soldering, resulting in residue which is able to be hold-on for several hours without causing corrosion problem on the joint before it is completely removed by warm water rinse, in comparison with an equivalent amount of organic acid flux which needs immediate washing of flux residue.

Application

Sn63Pb37 C6 core wire is easy to use for automatic, manual, rework, point and brush soldering. For the best soldering results, the recommended parameters are shown:

Solder Iron Tips:	All Types especially the tapered types
Soldering Temp:	300 - 400°C
Soldering Time:	1 - 3 secs

- Keep solder iron tips clean.
- Tinned iron tips before use.
- Wear gloves when soldering to avoid contaminating the wire.

(Note: Soldering parameters are dependent on tip type, soldering station wattage configuration, wire diameter and type of applications.)

Specification

Item	Result
Alloy Composition	Sn63Pb37
Alloy Melting Point	183°C
<small>DSC at 5°C/min</small>	
Flux Content	2.3 +/- 0.2 wt%
Halide Content	> 1wt%
<small>JIS Z 3197 8.1.4.2.1</small>	
<small>JIS Z 3197 8.1.1</small>	
Surface Insulation Resistance (after cleaning)	> 1 x 10 ⁸ Ω, Pass
<small>(85°C, 85%RH, 168hrs)</small>	
<small>IPC-TM-650 2.6.3.3</small>	
Electromigration	Pass
<small>(after cleaning)</small>	
<small>(85°C, 88.5%RH, 596hrs)</small>	
<small>IPC-TM-650 2.6.14.1</small>	
Copper Corrosion Test	Pass
<small>IPC-TM-650 2.6.15</small>	
<small>JIS Z 3197 8.4.1</small>	
Copper Mirror Test	Classified as "H", Pass
<small>IPC-TM-650 2.3.32</small>	
<small>JIS Z 3197 8.4.2</small>	
Flux Activity Classification	ROH1
<small>IPC J-STD-004</small>	
Spread Factor	> 95%
<small>JIS Z 3197 8.3.1.1</small>	

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RESIDUAL REMOVAL

Sn63Pb37 C-6 will leave a residue after soldering which is hygroscopic and ionizable. Complete removal, particularly for electrical and electronic applications, is recommended. Removal of ionizable salts can best be accomplished by washing the assembly in water, followed by a thorough warm water rinse. If the residue is charred due to excessive heating during soldering, some mechanical method will have to be used to remove the decomposed char. Ionizable salts can still be removed by aqueous cleaning methods.

STORAGE

Store the solder wire in a cool, dry and non-corrosive environment. Wrap up the solder wire when not in use to reduce exposure to environment. Sn63Pb37 C6 core wire can be kept for 2 years if proper storage conditions are observed.

HEALTH and SAFETY

Wear a chemical mask if the operators are allergic to the fumes released during soldering. For more information, please refer to Material Safety Data Sheet.

PACKAGING

Sn63Pb37 C6 core wire is commonly available in various diameters such as 0.5, 0.6, 0.8, 1.0, 1.2, 1.6 and 2.0 mm. For different diameters, please specify your requirements.

Packaging	0.25kg	0.50kg	1.0kg
Diameter (mm)	0.5 to 2.0	0.5 to 2.0	0.8 to 2.0

DISCLAIMER OF LIABILITY

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